Averatek Incorporated has announced American Standard Circuits as an A-SAP™ licensee. A-SAP™ is an advanced PCB manufacturing technology that enables feature sizes of 25 microns and below effectively providing PCB designers with new opportunities to address the challenges of next generation electronics.

“American Standard Circuits RF expertise in combination with our long term, relationship driven approach to customer development will serve the PCB design community well as we learn to fully understand all of the possible benefits of this emerging technology. Our goal at ASC is to always be at the forefront of technology and the A-SAP™ technology allows us to do that once again. We welcome the opportunity to work with the team at Averatek and redefining the future” said Anaya Vardya CEO American Standard Circuits”

Averatek is delighted to be working closely with American Standard Circuits” said Haris Basit, CEO of Averatek, “ASC has demonstrated significant capability in high-performance and high-frequency PCBs and Averatek’s ultra-high-density A-SAP™ process represents a strong complementary capability to support next generation electronics requirements.”

Averatek’s A-SAP™ is an advanced manufacturing process for printed circuit board fabrication with trace and space widths as narrow as 15 microns. This process can dramatically reduce area, layer count and weight of electronics systems as well as provide significant RF benefits. A-SAP™ has been designed to be easily integrated with traditional PCB manufacturing equipment and materials.

Partner Video.